

LTC3351EUFF

Hot Swappable Supercapacitor Charger, Backup Controller and System Monitor

DESCRIPTION

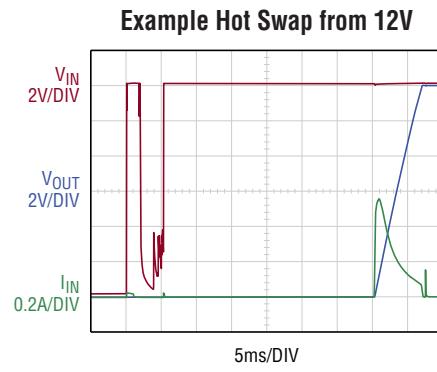
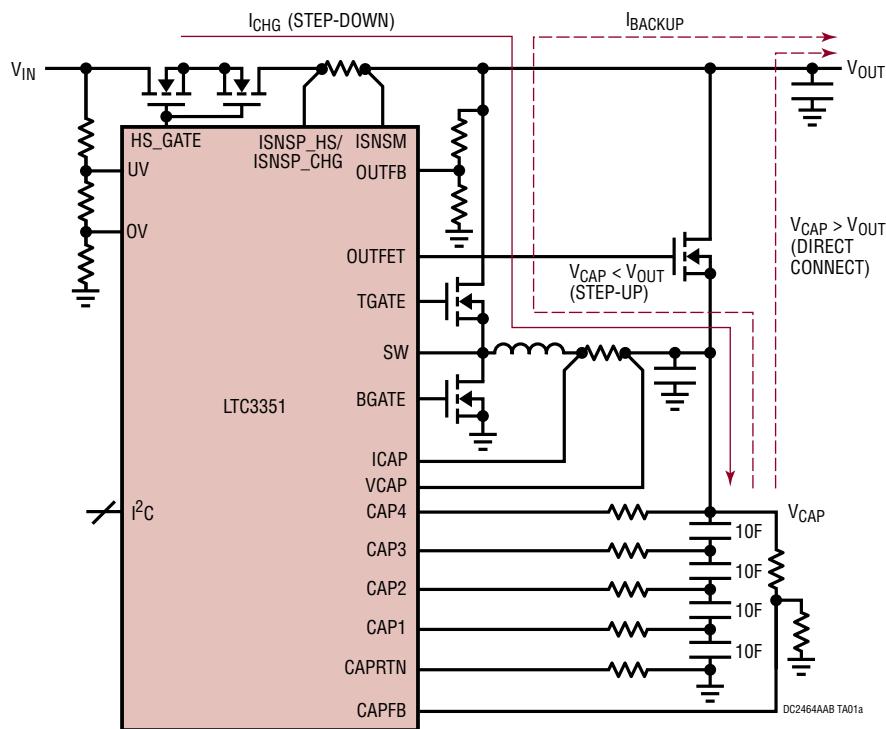
Demonstration circuit 2464A-A/2464A-B is a supercapacitor charger and backup controller with a hot swappable front end plus supercapacitor health and system monitoring; featuring the LTC[®]3351. The LTC3351 includes a buck supercapacitor charger and a backup boost controller. It has dual input hot swap FETs to control the inrush current when connected and to disconnect the input supply when an over current fault or input power loss occurs. An output ideal diode allows the

supercapacitors to supply the output when V_{CAP} is above the set backup voltage. As the capacitor stack voltage drops down to the set output voltage, the LTC3351 will operate as a boost regulator to supply the output until the energy in the supercapacitors is depleted.

Design files for this circuit board are available at
<http://www.linear.com/demo/DC2464A-A/B>

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TYPICAL APPLICATION



DC2464AAB TA01b

DEMO MANUAL

DC2464A-A/DC2464A-B

PERFORMANCE SUMMARY

Specifications are at $T_A = 25^\circ\text{C}$

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Input Supply Range	DC2464A-A DC2464A-B	11 20	12 24	18 30	V V
Charger Input Current Limit	DC2464A-A DC2464A-B		2.67 2		A A
Hot Swap Input Current Limit			4		A
V_{OUT} Backup Operating Voltage, Boost Mode	DC2464A-A DC2464A-B		6 18		V V
P_{OUT} Maximum Backup Power, Boost Mode	DC2464A-A DC2464A-B		25 36		W W
V_{CAP} Float Voltage	Buck Mode		10		V
Max Charge Current	DC2464A-A DC2464A-B		5.33 6.4		A A
t_{BACKUP}	$P_{\text{BACKUP}} = 25\text{W}$, $I_{\text{BOOST}} = 9.67\text{A}$, $3\text{V} \leq V_{\text{CAP}} \leq 8.4\text{V}$ $P_{\text{BACKUP}} = 36\text{W}$, $I_{\text{BOOST}} = 11.6\text{A}$, $3.7\text{V} \leq V_{\text{CAP}} \leq 8.4\text{V}$		2 1		s s

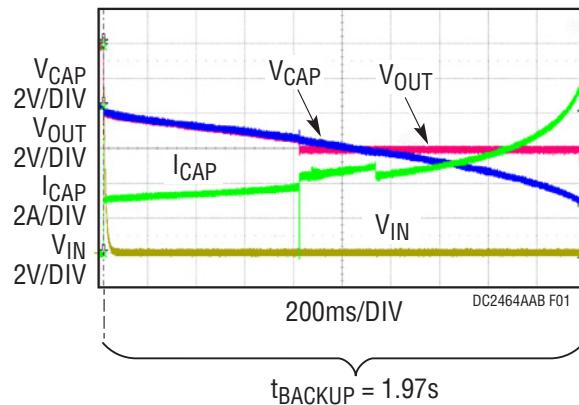


Figure 1. DC2464A-A 25W Backup

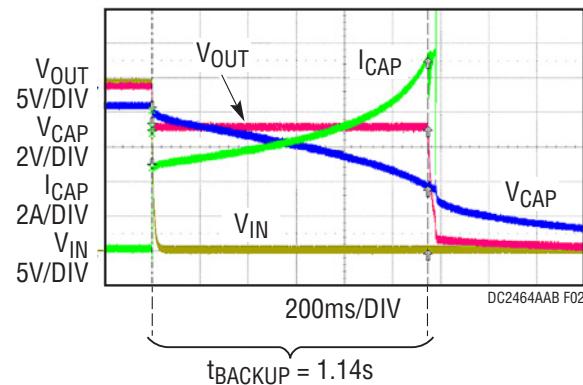


Figure 2. DC2464A-B 36W Backup

DEMO MANUAL DC2464A-A/DC2464A-B

BOARD PHOTO

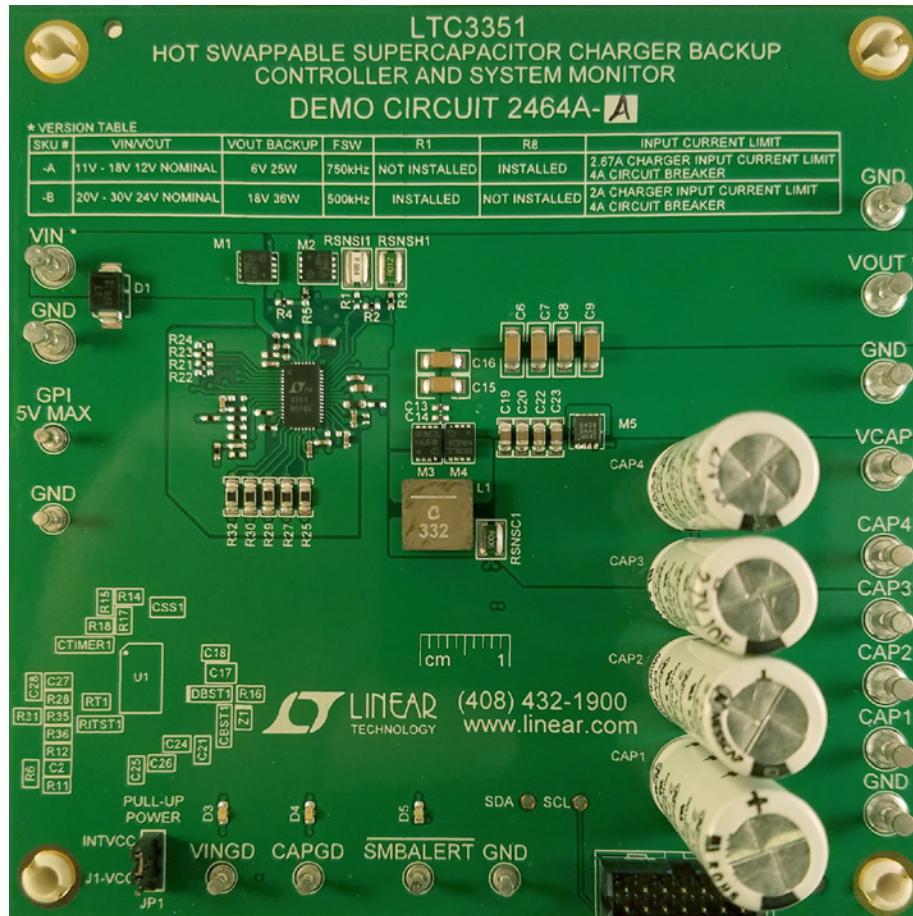


Figure 3. DC2464A-A Board Photo

DEMO MANUAL

DC2464A-A/DC2464A-B

QUICK START PROCEDURE

Obtain and connect a DC2026C board to the DC2464A board. Use short twisted pair leads for the power connections and start with the LOAD and the power supply OFF. Refer to Figures 4 and 5 for the proper measurement and equipment setup and follow the procedure below.

1. Refer to the DC2026C Quick Start Guide for QuikEval™ setup and software installation details.
 2. Make sure the USB cable is connected between the computer and the DC2026C controller board.
 3. Connect a 14-pin ribbon cable from the DC2026C board to the DC2464A board.
 4. Set jumper JP1 on the DC2464A board to the “INTV_{CC}” position.
 5. Start the ADI QuikEval program. This program should automatically detect the presence of the LTC3351 demo board (DC2464A) and activate the appropriate GUI, as seen in Figure 9.
 6. With power off, connect the appropriate supply, 0V to 20V (or 30V), 25W (or 36W) supply between the V_{IN} and GND terminals for the DC2624A-A or DC2624A-B as shown in Figure 4.
 7. Turn on and set the V_{IN} input power supply to 12V for DC2624A-A or 24V for the DC2624A-B and observe the V_{IN}, V_{OUT} and V_{CAP} voltages and the input and charge currents on the GUI.

NOTE. Make sure that the input voltage does not exceed 20V for the DC2624A-A or 33V for the DC2624A-B.
 8. On the LTC3351 Control Window “Charger/Control” tab, as shown in Figure 9, click on the CAP SCALE button so it displays “SMALL”. This will provide better time measurement resolution when measuring the capacitance.
 9. On the LTC3351 Control Window “Cap/ESR Details” tab as shown in Figure 14, enter “2” seconds in the “cap_i_on_settling” text box. This allows the capacitor voltage time to reach the linear portion of the discharge voltage slope.
 10. On the LTC3351 Control Window “Cap/ESR Details” tab as shown in Figure 14, enter “0.2” volts in the “cap_delta_v_setting” text box and then click on the Apply button on the bottom of the tab. This will provide a larger dV for more accuracy.
 11. On the LTC3351 Control Window, click on the CAP and ESR Measurement START button. An “In Process” indicator displays while the measurement is in process.
- NOTE. Supercapacitors initially have large leakage currents which causes the capacitance measurement to be low. The capacitor measurements will be more accurate after the 10F capacitors have been continuously charged for more than 30 minutes.
12. Connect a constant power load box between V_{OUT} and GND and set up to 25W for the DC2624A-A and 36W for the DC2624A-B.
 13. Connect an oscilloscope probe to V_{IN}, V_{OUT}, V_{CAP} and PFO. Set the oscilloscope to trigger on the falling edge of PFO.
 14. Remove the input power by unplugging the +V_{IN} supply cable and observe how the output drops to the regulation point and is maintained until the energy in the supercapacitors is exhausted.
 15. Turn the load off and set the oscilloscope to trigger on the rising edge of V_{IN}.
 16. Plugin the +V_{IN} supply cable and observe how V_{OUT} ramps up after the debounce time, showing the capacitors are charged up.
 17. The LTC3351 has the ability to monitor and report on the supercapacitor and system voltages, currents, die temperature and capacitor health. See the software section and data sheet for more information.
 18. The DC2464A can be modified to operate at different frequencies, operating voltages, input and boost currents. The “Hardware Config” tab allows the user to enter the appropriate changes so the GUI can report the correct measurements. See the software section for more details.

DEMO MANUAL

DC2464A-A/DC2464A-B

QUICK START PROCEDURE

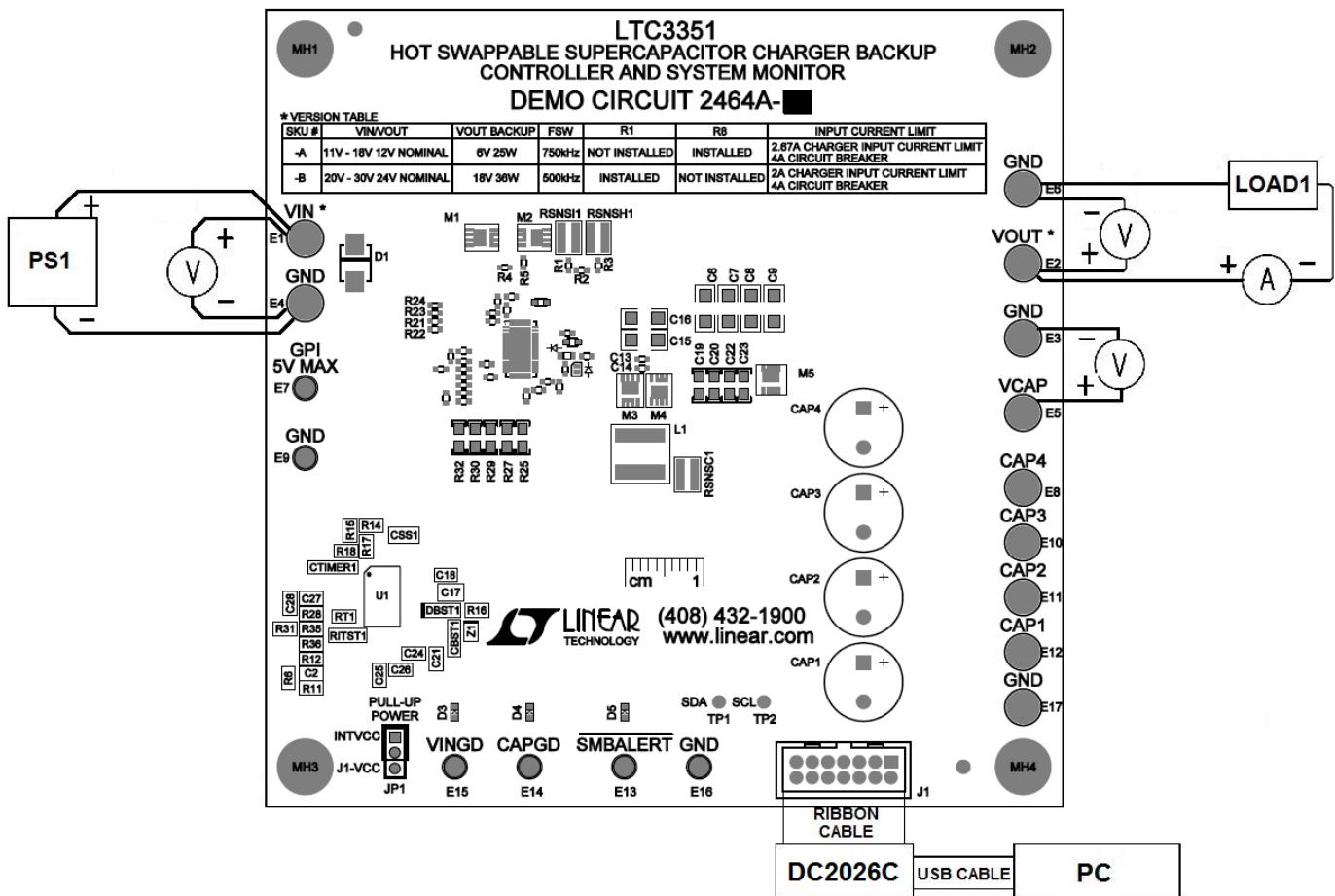


Figure 4. Proper Measurement Equipment Setup

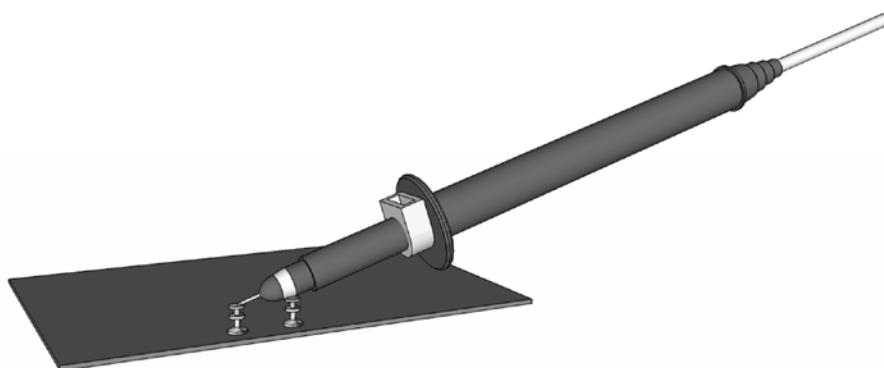


Figure 5. Measuring Input or Output Ripple

DEMO MANUAL

DC2464A-A/DC2464A-B

APPLICATION INFORMATION

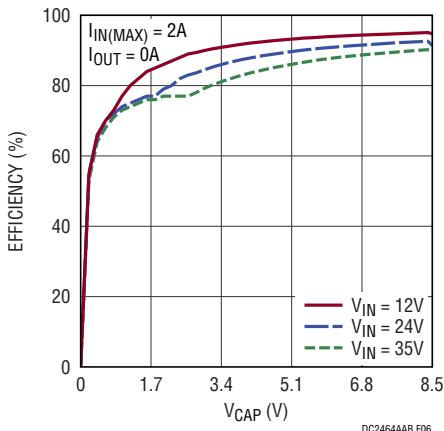


Figure 6. Charger Efficiency

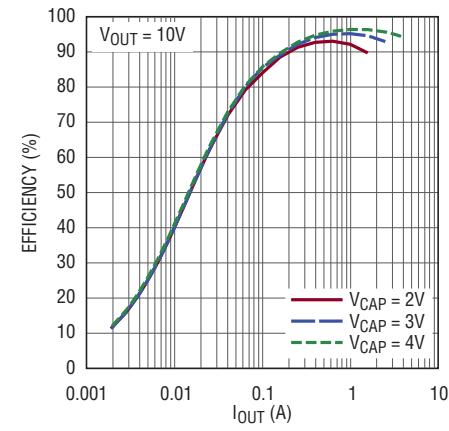


Figure 7. Boost Efficiency

The DC2464A was designed to safely connect to a powered system, charge up to four supercapacitors while supplying a load, and provide backup power when disconnected from the power system.

When first connected, the LTC3351, hot swap controller waits for the debounce period set by the CSS1 capacitor, about 26ms for this board. V_{OUT} will then ramp up at a dV/dt set also set by CSS1. After the V_{IN} is within the V_{INGD} range then the charger will charge the capacitors to the set float voltage.

The capacitors are initially charged to about 84% of the full-scale, the default CAPFB setting. As the capacitors age decreasing their backup capability, the capacitor stack

voltage can be increased the backup time as needed. This can increase the usage life of the capacitors.

When the power is disconnected, the LTC3351 quickly switches from charge mode to backup mode. If the set backup voltage is set below the V_{CAP} voltage, the output power is initially powered from V_{CAP} thru the output ideal diode as shown in Figure 8. As V_{CAP} approaches the set V_{OUT} backup voltage then the backup boost regulator starts to hold V_{OUT} at the set voltage.

If the set V_{OUT} backup voltage is set higher than V_{OUT} , the backup boost regulator starts immediately to pump up and maintain the V_{OUT} to the set backup voltage.

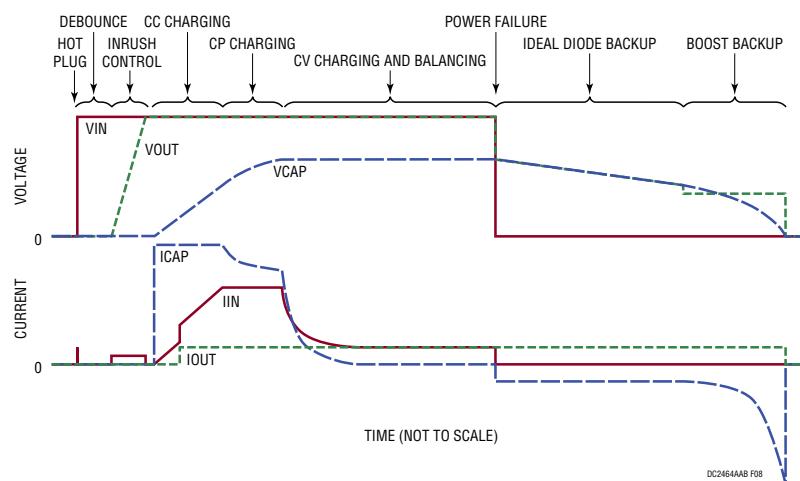


Figure 8. Charge and Discharge Cycle

USING THE LTC3351 SOFTWARE

The LTC3351 program provides the ability to measure and monitor the system voltages and currents plus the health of the supercapacitors. It also allows the user to set up alarms to report on specific events such as power fail or CAP measurement done. Refer to Figure 9 for an illustration of the LTC3351 control window.

VIEW LTC3351 PRODUCT PAGE button opens an Internet browser and searches the ADI website for information on the LTC3351 when an Internet connection is available.

CAP and ESR Measurement START button starts a capacitor and ESR measurement. An indicator below the START button indicates the status of the CAP/ESR measurement. The different states are: In Process, Done, Pending or Failed.

Number of Caps Selected text box indicates the number of capacitors selected using the CAP_SLCTx pins.

Hot Swap ENABLED button sets the `ctl_hotswap_disable` in the `ctl_reg`. V_{IN} is disconnected when this bit is set to simulate a power loss. This bit is automatically reset if the `min_vout_hs_disable` voltage has been reached.

Clear SMBUS ALERT button sends an SMBus alert response address to clear the SMBALERT. NOTE: the condition that caused the SMBALERT must be cleared before the SMBALERT signal can be cleared.

CAP text box indicates the latest measured capacitance in Farads for large capacitors and mF for smaller capacitors. This measurement is based on the CAP scale setting in the control register plus the current and oscillator resistor settings on the Hardware Config tab.

ESR text box indicates the latest measured ESR in $m\Omega$.

VCAP text box indicates the latest V_{CAP} voltage in volts when the VCAP ADC is enabled.

ICHRG text box indicates the latest measured charge/boost current in amps when the ICHRG ADC is enabled. This measurement is based on the RSNSC setting on the Hardware Config tab.

VCAPx text box indicates the latest measured capacitor voltage in volts for the corresponding VCAP when the VCAP ADC is enabled.

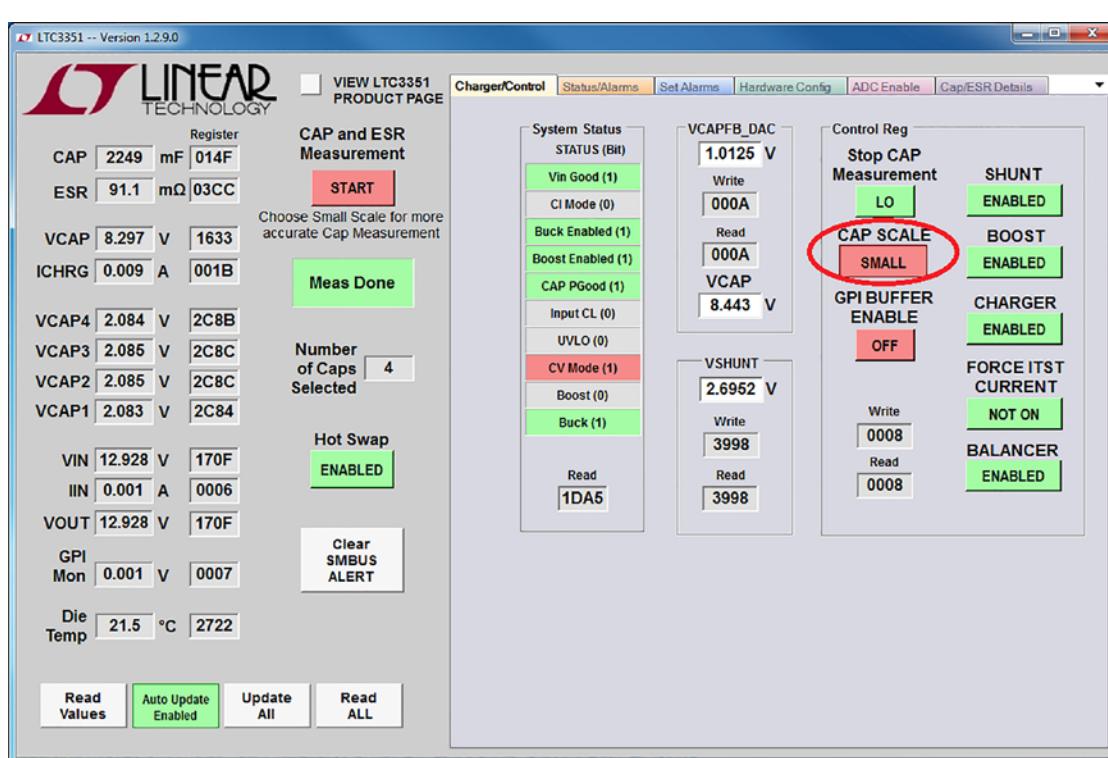


Figure 9. LTC3351 Control Window

DEMO MANUAL

DC2464A-A/DC2464A-B

USING THE LTC3351 SOFTWARE

VIN text box indicates the latest measured input voltage in volts when the VIN ADC is enabled.

IIN text box indicates the latest measured input current in amps when the IIN ADC is enabled. This measurement is based on the RSNSI setting on the Hardware Config tab.

VOUT text box indicates the latest measured V_{OUT} in volts when the VOUT text box is enabled.

GPI Mon text box indicates the latest measured GPI voltage in volts when the GPI Mon ADC is enabled. An internal buffer can be enabled for measuring high impedance inputs.

Die Temp text box displays the latest internally measured die temperature in °C when the Die Temp ADC is enabled.

Register text boxes displays the associated register values in hexadecimal format.

Read Values button causes the LTC3351 to read the ADC measured values. This is useful when the LTC3351 GUI “Auto Update” is disabled.

Auto Update Enabled/Disabled button causes the LTC3351 to read the LTC3351 registers periodically and writes to any register changed when enabled. The Read Values, Read All, or Update All buttons can be used instead to update the registers when in the disabled state.

Read All button causes the LTC3351 to read the LTC3351 registers. This is useful when the LTC3351 GUI Auto Update is disabled.

Charger Control Tab

The Charger Control tab contains the indicators and controls for the capacitor charger and monitor plus the GPI buffer enable as shown in Figure 9.

System Status STATUS (Bit) indicates when the associated chrg_status register bits are set. See the data sheet for more information on these bits.

System Status Read text box displays the last read sys_status register value in hexadecimal format.

VCAPFB_DAC text box allows the user to set the CAPFB reference voltage from 0.6375V to 1.2V in 37.5mV increments. The value in the text box is rounded to the nearest mV. The VCAP text box is also updated with the calculated

value of the CAPFB reverence voltage and the resistor network entered on the Hardware Config tab.

VCAPFB_DAC Write text box displays the value that will be or has been written to the vcapfb_dac register in hexadeciml format.

VCAPFB_DAC Read text box displays the last value read from the vcapfb_dac register in hexadeciml format.

VCAP text box allows the user to set the V_{CAP} float voltage within the limits of the CAPFB reference voltage and the CAPFB resistor network on the Hardware Config tab. The value in the text box is rounded to the nearest mV. The VCAPFB_DAC text box is also updated with the calculated value using the CAPFB resistor network entered on the Hardware Config tab.

VSHUNT text box allows the user to set the shunt regulator voltage up to 5.5V. When set below 3.6V, the charger will limit current and the active shunts will shunt current to prevent this voltage from being exceeded. When programmed above 3.6V no current will be shunted, however, the charge current will be reduced as described. As a capacitor voltage nears this level, the charge current will be reduced. The shunt voltage will be reset to the default value of 2.6952 every time INT V_{CC} is restored.

VSHUNT Write text box displays the value that will be or has been written to the VSHUNT register in hexadeciml format.

VSHUNT Read text box displays the last value read from the VSHUNT register in hexadeciml format.

Stop CAP Measurement sets the ctl_stop_cap_esr_meas bit in the ctl_reg register. This will cause any CAP/ESR measurement in process to stop. This bit will reset when the measurement has ceased.

CAP SCALE button sets the cap scale from large scale, default scale for larger capacitors, to small scale for smaller capacitors like used on the DC2464A. The resolution is increased by 100× in small scale.

GPI BUFFER ENABLE button sets the ctl_gpi_buffer_en bit when enabling the GPI input buffer. When the GPI BUFFER ENABLE is off then the GPI input is measured without the input buffer.

USING THE LTC3351 SOFTWARE

SHUNT ENABLED button disables the shunt regulator when set. When not set, the shunt regulator will prevent the caps from charging over the set V_{SHUNT} voltage.

BOOST ENABLED button disables the boost regulator when set. When not set, the boost regulator will operate as required in backup mode.

CHARGER ENABLED button disables the charger when set. When not set, charger will operate when possible.

FORCE ITST CURRENT button turns on the internal capacitor discharge current source. This can be used to discharge the capacitors or to manually measure the capacitors. NOTE: this does not disable the charger. Select the CHARGER ENABLED button to disable the charger.

BALANCER ENABLED button disables the capacitor balancers when set. When not set, the balancers will balance the capacitors about 10mV of each other.

Control Reg Write text box displays the value that will be or has been written to the `ctl_reg` register in hexadecimal format.

Control Reg Read text box displays the last value read from the `ctl_reg` register in hexadecimal format.

Status/Alarms Tab

The Status/Alarms tab contains the indicators for the `monitor_status_reg` and `alarm_reg` bits plus control buttons for the Monitor Status Mask, Alarm Mask and Alarm Clear bits as shown in Figure 10.

Monitor Status Status (Bit) indicate when the associated monitor_status_reg bits are set. See the data sheet for more information on these bits.

Monitor Status Read text box displays the last read monitor_status_reg value in hexadecimal format.

Mask Monitor Status buttons will allow the rising edge of the associated monitor status bit to trigger the SMBALERT when the mask bit is set to 1.

Mask Monitor Write text box displays the value that will be or has been written to the `monitor_status_mask_reg` in hexadecimal format.

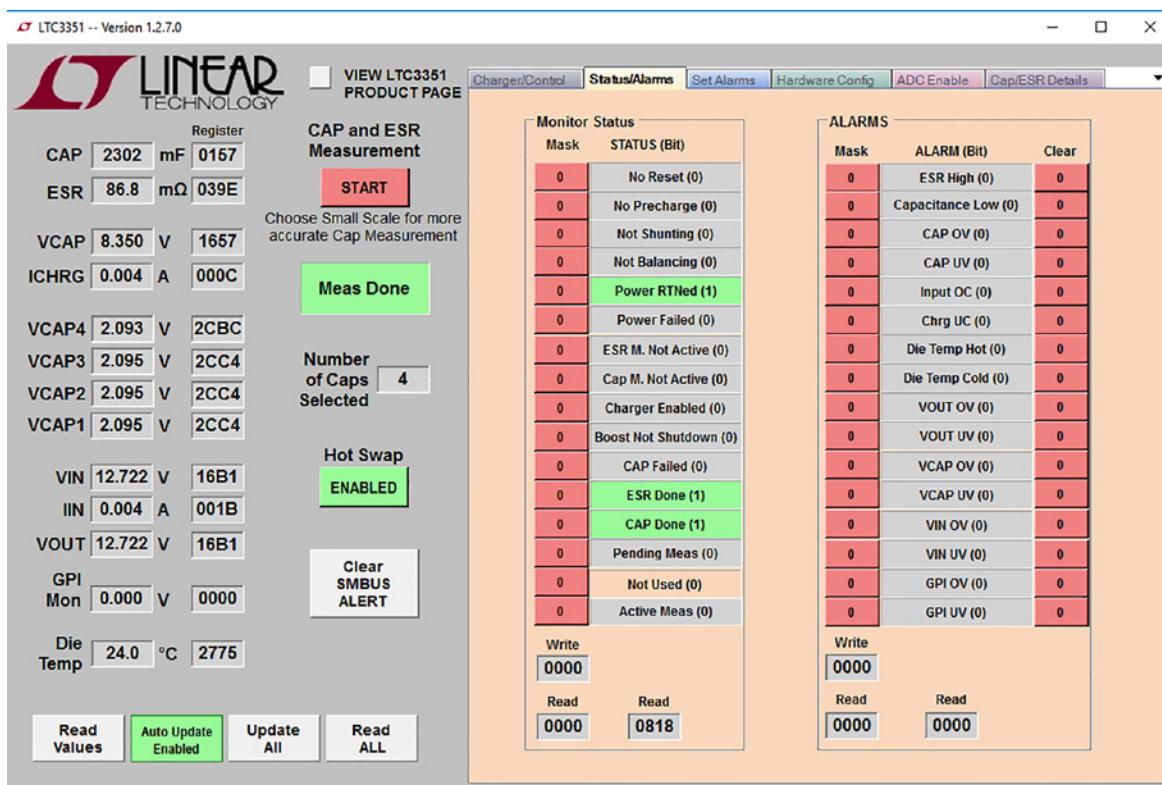


Figure 10. Status/Alarms Tab

DEMO MANUAL

DC2464A-A/DC2464A-B

USING THE LTC3351 SOFTWARE

Mask Monitor Read text box displays the last read monitor_status_mask_reg value in hexadecimal format.

ALARM (Bit) indicate when the associated alarm_reg bits are set. See the data sheet for more information on these bits.

Alarm Read text box displays the last read alarm_reg value in hexadecimal format.

Mask Alarm buttons will allow the associated alarm bit to trigger the SMBALERT when the mask bit is set to 1.

Mask Alarm Write text box displays the value that will be or has been written to the alarm_mask_reg in hexadecimal format.

Mask Alarm Read text box displays the last alarm_mask_reg value in hexadecimal format.

Clear Alarm buttons will cause the associated alarm to clear when the alarm condition no longer exists by writing a “0” in the appropriate alarm_reg bit.

Set Alarms Tab

The Set Alarms tab contains text boxes to allow the user to set specific levels for each alarm register as shown in Figure 11. Each alarm has an associated Write text box to display the value that will be or has been written to the associated register in hexadecimal format. Each alarm also has an associated Read text box which displays the last read contents of the associated register in hexadecimal format.

VIN/VOUT/VCAP/CAP/GPI UV Alarm text boxes allow the user to enter a voltage that will trigger an alarm when the associated voltage drops below the entered voltage value and the associated alarm mask bit is set.

VIN/VOUT/VCAP/CAP/GPI OV Alarm text boxes allow the user to enter a voltage that will trigger an alarm when the associated voltage rises above the entered voltage value and the associated alarm mask bit is set.

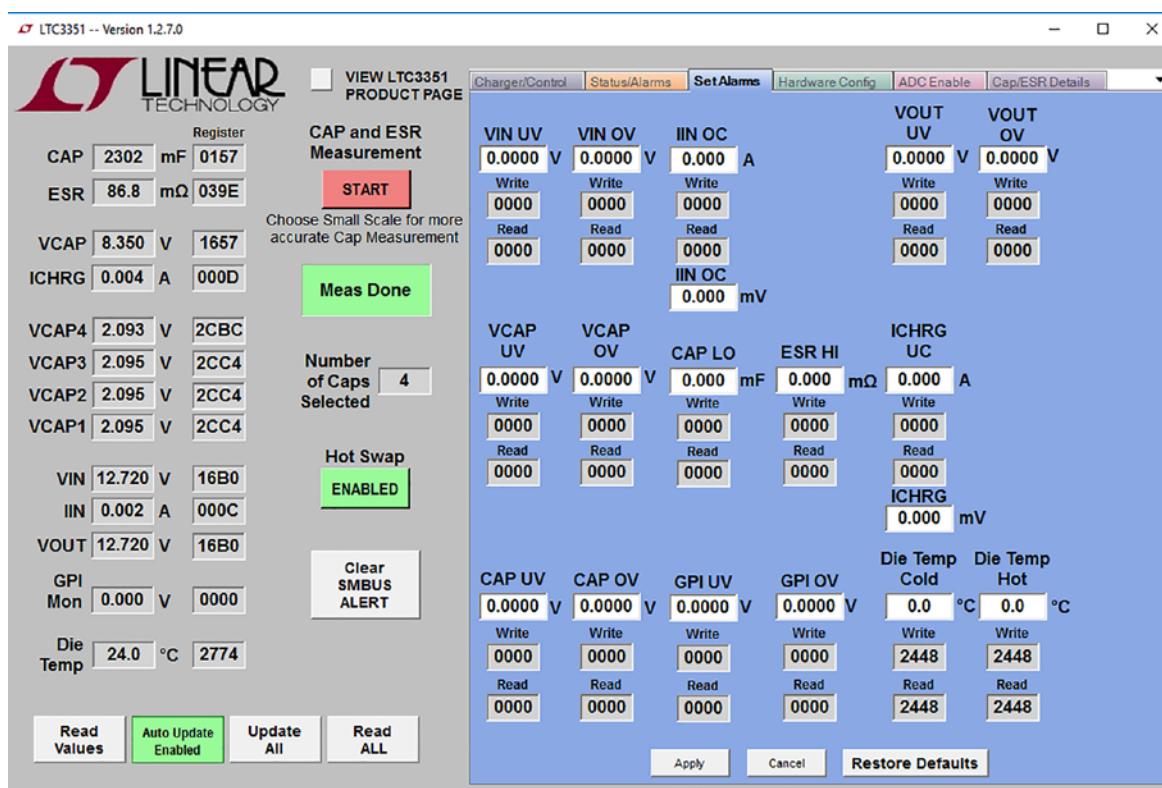


Figure 11. Set Alarms Tab

USING THE LTC3351 SOFTWARE

IIN OC alarm text boxes allow the user to enter a current or the voltage across the sense resistor that will trigger an alarm when the input current increase above the entered value and the mask_alarm_iin_oc bit is set.

CAP LO alarm text box allows the user to enter a capacitance based on the current ctl_cap_scale setting in the ctl_reg. A CAP LO alarm will be triggered if the measured capacitance is lower than the entered value and the mask_alarm_cap_lo bit is set.

ESR HI alarm text box allows the user to enter an ESR value based on the RSNSC resistor value entered in the Hardware Config tab. An ESR HI alarm will be triggered if the measured ESR is higher than the entered value and the mask_alarm_esr_hi bit is set.

ICHRG UC alarm text boxes allow the user to enter a current or the voltage across the sense resistor that will trigger an alarm when the charge current decreases below the entered value and the mask_alarm_ichrg_uc bit is set.

Die Temp Cold alarm text box allows the user to enter a die temperature in °C that will trigger an alarm when the temperature decreases below the entered value and the mask_alarm_dtemp_cold bit is set.

Die Temp Hot alarm text box allows the user to enter a die temperature in °C that will trigger an alarm when the temperature increases above the entered value and the mask_alarm_dtemp_hot bit is set.

Apply button writes to the alarm registers and reads the values back from the LTC3351.

Cancel button changes all the entered values that have not yet been written to the LTC3351 back to their previous values.

Restore Defaults button changes the LTC3351 alarm registers back to the default values determined from the GUI. This does not set the alarm to the LTC3351's default settings of 0x0000.

Hardware Config Tab

The Hardware Config tab, shown in Figure 12, contains text boxes to allow the user to enter the values to configure the necessary resistors to match the configuration of the demo board. These values are used by the GUI to calculate measured CAP and ESR values, display input/charge currents and max VCAP voltage for a given reference setting. These values are also used in the Set Alarm tab text boxes.

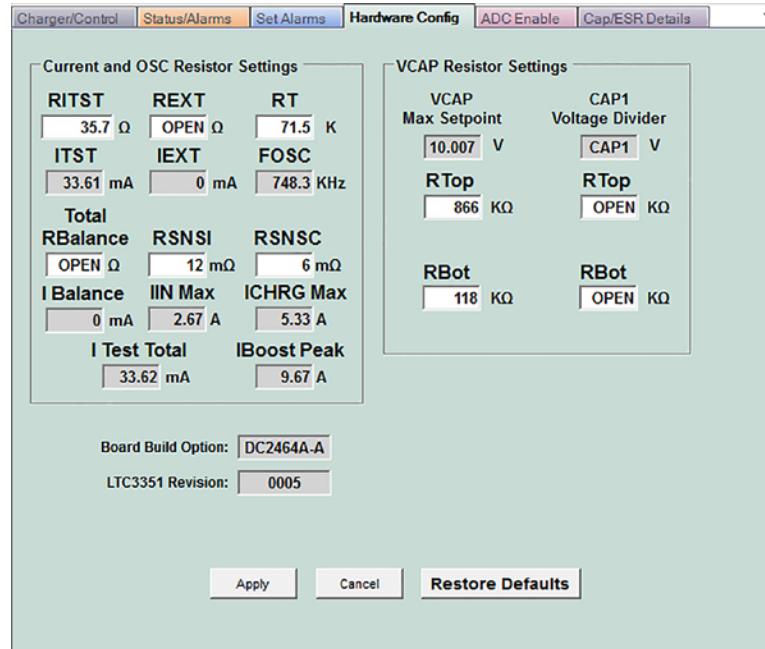


Figure 12. Hardware Config Tab

DEMO MANUAL

DC2464A-A/DC2464A-B

USING THE LTC3351 SOFTWARE

RITST text box allows the user to enter the RITST resistor in Ω . The calculated test current setting is displayed in mA.

REXT text box allows the user to enter the external load resistance, R28 and R29, added in Ω if any. Enter 0 if there is not any external loading and OPEN will be displayed in the text box. See the Using Large Capacitor section for more details.

RT text box allows the user to enter the R_T resistor in $k\Omega$. The calculated oscillator setting is displayed in kHz.

Total RBalance text box allows the user to enter the equivalent total balance resistance in Ω if any for capacitance stacks or packs that have external balancing. Enter 0 if there is not any external balancing and OPEN will be displayed in the text box.

RSNSI text box allows the user to enter the RSNSI resistor in $m\Omega$. The calculated input current limit setting is displayed in Amps. This is the total resistance sensed between the isnsp_chg and the ISNSM pin. If R8 is populated and R1 is not, then it should be the value of the RSNSH1 resistor. If R8 is not populated and R1 is, then it should be the total of the RSNSI1 and RSNSH1 resistors.

RSNSC text box allows the user to enter the RSNSC resistor in $m\Omega$. The calculated maximum charge current setting is displayed in Amps.

VCAP Resistor Settings text boxes allow the user to enter the CAPFB resistor divider network in $k\Omega$. The calculated maximum VCAP set point is displayed in volts.

CAP1 Voltage Divider text boxes allow the user to enter the CAP1 resistor divider network in $k\Omega$ if used. This could be used if a large capacitor stack or a capacitor pack with its own balancing was used. The displayed CAP1 voltage is calculated from the maximum VCAP voltage. Enter 0 in the CAP1 Voltage Divider RTOP and RBOT text boxes then OPEN will be displayed in both text boxes.

ADC Enable Tab

The ADC Enable tab contains control buttons to enable the ADC measurements when charging and when operating on backup power. It also contains a text box to configure the delay for each ADC measurement, and configurable voltage thresholds which require specific ADC measurements to be enabled.

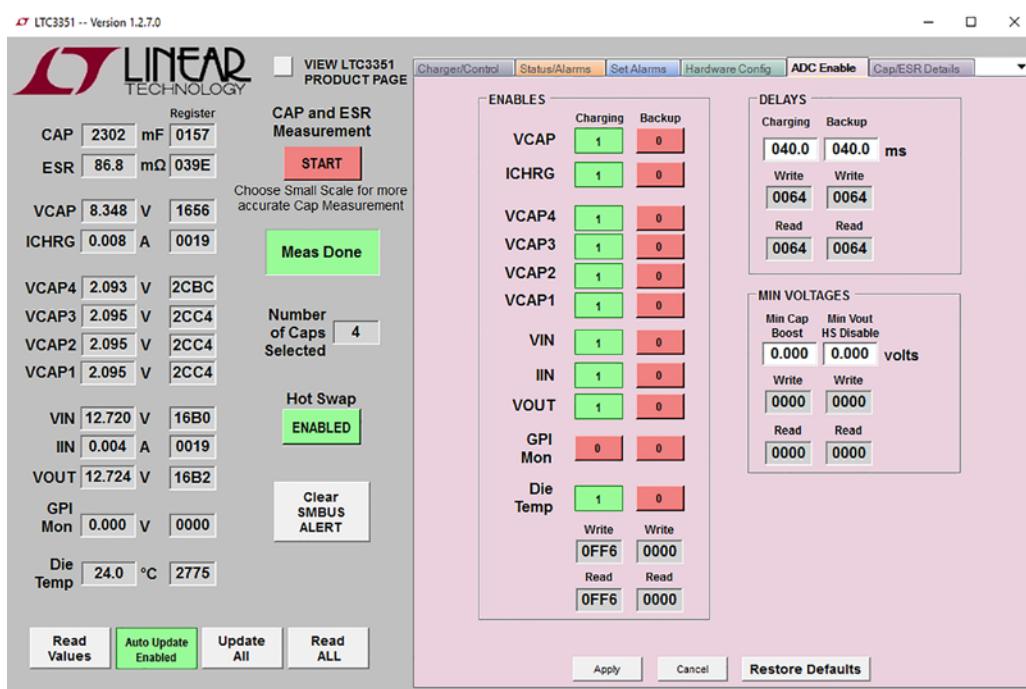


Figure 13. ADC Enable Tab

USING THE LTC3351 SOFTWARE

Each control has an associated Write text box to display the value that will be or has been written to the associated register in hexadecimal format. Each control also has an associated Read text box which displays the last read contents of the associated register in hexadecimal format.

At the bottom of the tab are buttons to Apply, Cancel, and Restore Defaults for the settings on this tab.

ENABLES. These buttons enable and disable the ADC measurements in the LTC3351. Press the button to toggle the measurement between 1 (on) and 0 (off).

DELAYS. Set these text boxes to configure the wait time between ADC measurements in ms.

MIN CAP BOOST VOLTAGE. The Min Cap Boost setting requires the applicable VCAPx measurements to be enabled during backup. It controls the minimum capacitor cell voltage at which the LTC3351 will continue powering VOUT with the boost regulator.

MIN VOUT HS DISABLE VOLTAGE. The VOUT to match GUI Disable setting requires the VOUT measurement to

be enabled in backup. It controls the minimum voltage at which the LTC3351 will disable Hot Swap and return to charging the capacitors when V_{IN} power becomes available. The ctl_hotswap_disable bit is also cleared when this voltage is reached.

APPLY/CANCEL/RESTORE DEFAULTS. These buttons write and read the settings between the LTC3351 and the GUI. Apply will write the selected settings to the LTC3351, Cancel will restore the GUI to the settings in the LTC3351, and Restore Defaults will return both the GUI and the LTC3351 to the defaults for the IC.

CAP/ESR Details Tab

The CAP/ESR Details tab contains text boxes to configure the measurements of the capacitance and ESR for each capacitor. When a CAP/ESR measurement is performed, intermediate calculations are reported in the registers displayed on this tab which can be used to evaluate the readings. The individual capacitance and ESR for each capacitor are calculated and reported at the bottom of the page.

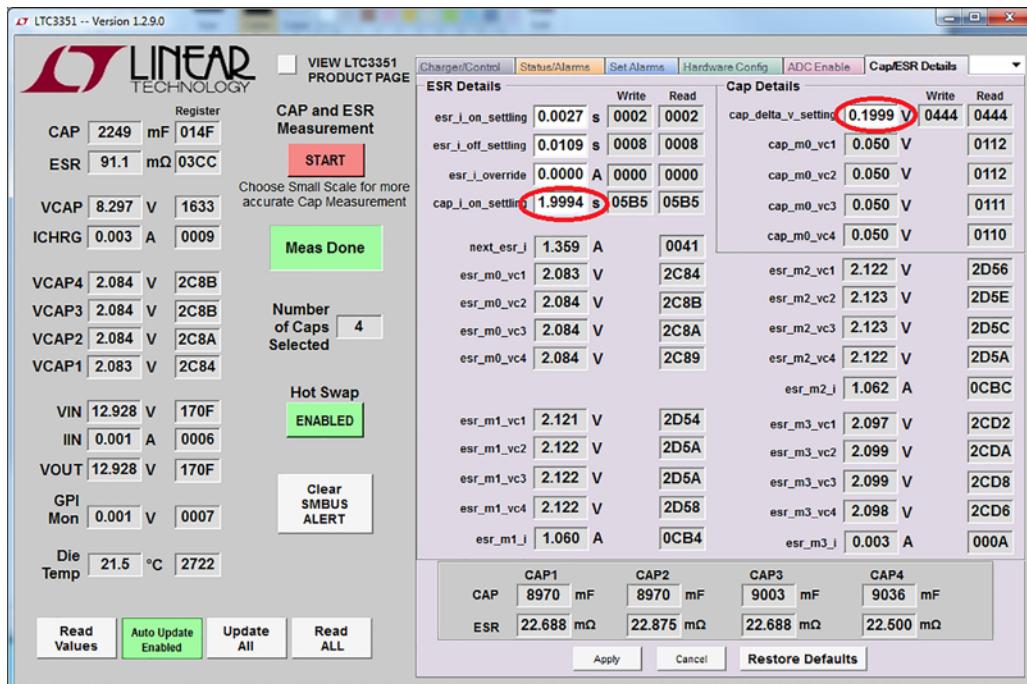


Figure 14. Cap/ESR Details Tab

DEMO MANUAL

DC2464A-A/DC2464A-B

USING THE LTC3351 SOFTWARE

Each control has an associated Write text box to display the value that will be or has been written to the associated register in hexadecimal format. Each control also has an associated Read text box which displays the last read contents of the associated register in hexadecimal format.

ESR DETAILS. The text boxes at the top of this section contain the ESR and capacitor measurement settling times which can be adjusted for better measurement accuracy. The `esr_i_override` current is used to force a specific charge current to use when performing the ESR measurement. This is used if the `next_esr_i` current plus the load will cause the part to reach the input current limit and create an inaccurate ESR measurement. Refer to the ESR and Capacitor Measurement section of the LTC3351 data sheet for more information on the capacitor and ESR measurement.

When the ESR measurement is started and allowed to complete, the intermediate calculations performed for the final reported ESR value are displayed in this section.

CAP DETAILS. The `cap_delta_v_setting` text box at the top of this section contains the voltage difference used to perform the capacitance measurement. The voltage will be charged to $1.25^* \text{ cap_delta_v_setting}$, turn on the discharge current source, wait for the `cap_i_on_settling` time and then measure the capacitor stack voltage. The LTC3351 then measures the time it takes to discharge the `cap_delta_v_setting` voltage. When the measurement has completed the charger turns on and maintains the float voltage.

When the capacitance measurement is started and allowed to complete, the voltage difference per capacitor is displayed in this section.

CAP/ESR PER CAPACITOR. The Capacitance and ESR for VCAP1/VCAP2/VCAP3/VCAP4 are reported at the bottom of the tab, using the reported details in the other sections.

APPLY/CANCEL/RESTORE DEFAULTS. These buttons write and read the settings between the LTC3351 and the GUI. Apply will write the selected settings to the LTC3351, Cancel will restore the GUI to the settings in the LTC3351, and Restore Defaults will return both the GUI and the LTC3351 to the defaults for the IC.

The DC2464A standard configuration is designed for supercapacitors of 200F or less. The standard configuration measures the time it takes to discharge the capacitor stack by 100mV at 33.6mA to calculate the capacitance. Larger supercapacitors have larger leakage currents, some over a milliamp, causing an inaccuracy in the capacitive measurement. To increase the measurement accuracy, the capacitor test current can be increased by loading the capacitor stack with external resistors, R50 and R51, during the measurement. The low threshold N-MOSFET, M6, is controlled by the ITST pin which turns on the load when needed.

USING LARGE CAPACITORS

Optional External Test Current

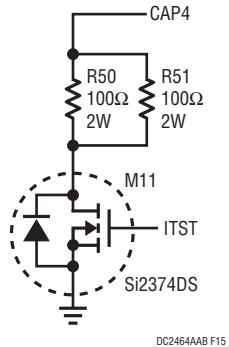


Figure 15. External Test Current

When using this circuit, the test current will be the original ITST circuit current plus an additional current due to the capacitor stack voltage across the resistor. This requires a modified equation for converting meas_cap to capacitance.

This equation for small scale is:

$$C = \frac{-56 \cdot 10^{-9} \cdot R_t \cdot \text{meas_cap}}{R \cdot \ln \left[1 - \frac{\Delta V_{\text{CAP}}}{1.2V \cdot \frac{R}{R_{\text{TST}}} + V_{\text{CAP}}} \right]}$$

Larger capacitors also take longer to balance. If one capacitor is far enough off balance that it reaches the shunt voltage before the capacitor stack is fully charged. The charge current effectively is reduced to the shunt current until the capacitor stack is fully charged. The standard DC2464A board is set up for a 500mA maximum shunt current. This current can be increased by turning on external shunt resistors across each capacitor, R42 thru R49. The controlling FETs, M7 thru M10, are turned on from the voltage drop across the corresponding shunt resistor when the shunt regulator turns on. The 2.7Ω shunt resistors between the supercapacitor and the CAPx pin as shown in Figure 16 can be used to provide a larger shunt current.

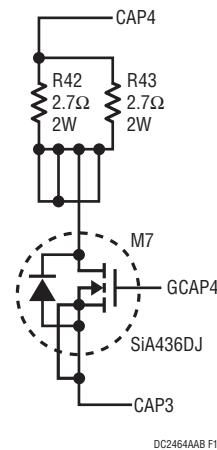


Figure 16. High Current Shunting

$$I_{\text{SHUNT}} = \frac{V_{\text{SHUNT}}}{2 \cdot R_{\text{SHUNT}}} + \frac{V_{\text{SHUNT}}}{R_{\text{SHUNT(OPT)}}}$$

DEMO MANUAL

DC2464A-A/DC2464A-B

PARTS LIST – DC2464A-A

ITEM	QTY	REFERENCE	PART DESCRIPTION	MANUFACTURER/PART NUMBER
Required Circuit Components				
1	1	C1	CAP, 1µF, X5R, 50V, 10%, 0603, AEC-Q200	TDK, CGA3E3X5R1H105K080AB
2	1	C2	CAP, 120pF, COG, 50V, 5%, 0402	MURATA, GRM1555C1H121JA01D
3	6	C6-C9, C15, C16	CAP, 47µF, X5R, 25V, 20%, 1206	TDK, C3216X5R1E476M160AC
4	2	C13, C14	CAP, 2.2µF, X5R, 25V, 10%, 0402	TDK, C1005X5R1E225K050BC
5	1	C17	CAP, 4.7µF, X5R, 16V, 10%, 0603	AVX, 0603YD475KAT2A
6	4	C18, C25, C26, CBST1	CAP, 0.1µF, X7R, 16V, 10%, 0402	AVX, 0402YC104KAT2A
7	4	C19, C20, C22, C23	CAP, 22µF, X5R, 16V, 20%, 0805	TDK, C2012X5R1C226M125AC
8	1	C21	CAP, 1µF, X5R, 16V, 10%, 0402	TAIYO YUDEN, EMK105BJ105KV-F
9	1	C28	CAP, 0.01µF, X7R, 16V, 10%, 0402	AVX, 0402YC103KAT2A
10	4	CAP1-CAP4	CAP, 10F, ULTRA, 2.7V, -10/+20%, THT, RADIAL	NESSCAP, ESHSR-0010C0-002R7
11	1	CSS1	CAP CER., 0.022µF, 100V, X7R, 0603	TDK, C1608X7R2A223K080AA
12	1	CTIMER1	CAP, 0.033µF, X5R, 16V, 10%, 0402, AEC-Q200	TDK, CGA2B2X5R1C333K050BA
13	1	D1	DIODE, TVS, 18V, 600W, SMB	DIODES INC., SMBJ18A-13-F
14	1	DBST1	DIODE, GP SWITCHING, 80V, 125mA, SOD523, AEC-Q10X	DIODES INC., 1N4448HWT-7
15	1	L1	IND., 3.3µH, PWR., 20%, 10A, 21.45mΩ, SMD 7.5mm × 7.5mm, AEC-Q200	COILCRAFT, XAL7030-332MEB
16	2	M1, M2	XSTR., MOSFET, N-CH, 25V, 23A, TSDSON-8	INFINEON, BSZ018NE2LSATMA1
17	2	M3, M4	XSTR., MOSFET, N-CH, 25V, 12A, TSDSON-8	INFINEON, BSZ060NE2LSATMA1
18	1	M5	XSTR., MOSFET, N-CH, 20V, 16A, PowerPAK 1212-8	VISHAY, SiS438DN-T1-GE3
19	2	R4, R5	RES., 10Ω, 5%, 1/16W, 0402	VISHAY, CRCW040210R0JNED
20	1	R11	RES., 649k, 1%, 1/16W, 0402	NIC, NRC04F6493TRF
21	1	R12	RES., 162k, 1%, 1/16W, 0402	VISHAY, CRCW0402162KFKED
22	1	R14	RES., 100Ω, 1%, 1/16W, 0402	NIC, NRC04F1000TRF
23	1	R15	RES., 665k, 1%, 1/16W, 0402	NIC, NRC04F6653TRF
24	1	R17	RES., 33.2k, 1%, 1/16W, 0402	VISHAY, CRCW040233K2FKED
25	1	R18	RES., AEC-Q200, 49.9k, 1%, 1/16W, 0402	PANASONIC, ERJ2RKF4992X
26	5	R25, R27, R29, R30, R32	RES., ANTI-SURGE, AEC-Q200, 2.7Ω, 5%, 1/2W, 0805	PANASONIC, ERJ-P6WJ2R7V
27	1	R35	RES., 866k, 1%, 1/16W, 0402	NIC, NRC04F8663TRF
28	1	R36	RES., 118k, 1%, 1/16W, 0402	NIC, NRC04F1183TRF
29	1	RITST1	RES., AEC-Q200, 35.7Ω, 1%, 1/16W, 0402	VISHAY, CRCW040235R7FKED
30	1	RSNSC1	RES., SENSE, 0.006Ω, 1%, 1W, 1206 (0612)	SUSUMU
31	1	RSNSH1	RES., SENSE, 0.012Ω, 1%, 1W, 1206 (0612)	SUSUMU, PRL1632-R012-F-T1
32	1	RSNSI1	RES., SENSE, AEC-Q200, 0.004Ω, 1%, 1.5W, 1206 (0612)	SUSUMU, KRL3216E-C-R004-F-T1
33	1	RT1	RES., 71.5k, 1%, 1/16W, 0402	NIC, NRC04F7152TRF
34	1	U1	IC, HOT SWAPPABLE SUPERCAPACITOR CHARGER BACKUP CONTROLLER AND SYSTEM MONITOR	ADI, LTC3351EUFF#PBF

DEMO MANUAL

DC2464A-A/DC2464A-B

PARTS LIST – DC2464A-A

ITEM	QTY	REFERENCE	PART DESCRIPTION	MANUFACTURER/PART NUMBER
Additional Demo Board Circuit Components				
35	0	C3, C4	DNP	
36	0	C5, C12, C27	DNP	
37	0	C10, C11	DNP	
38	0	C24	DNP	
39	1	C29	CAP., 0.1µF, X7R, 16V, 10%, 0402	AVX, 0402YC104KAT2A
40	0	D2	DNP	
41	2	D3, D4	LED, GREEN, MILKY WHITE DIFF., 0603 SMD, 565nm	LUMEX, SML-LX0603GW-TR
42	1	D5	LED, SUPER RED, MILKY WHITE DIFF., 0603 SMD, 660nm	LUMEX, SML-LX0603SRW-TR
43	2	D6, D7	DNP	
44	0	M5	DNP	
45	0	M6	DNP	
46	0	M7-M10	DNP	
47	0	M11	DNP	
48	1	Q1	XSTR., MOSFET, DUAL N-CH, 20V, 1.3A, SOT-363	VISHAY, Si1922EDH-T1-GE3
49	0	R1	DNP	
50	2	R2, R3	RES., 1Ω, 1%, 1/16W, 0402	VISHAY, CRCW04021R00FKED
51	2	R6, R31	RES., 20Ω, 1%, 1/16W, 0402	NIC, NRC04F20R0TRF
52	0	R7, R9, R22, R24	DNP	
53	0	R8	DNP	
54	6	R8, R10, R13, R16, R28, R52	RES., 0Ω, 1/16W, 0402	ROHM, MCR01MZPJ000
55	2	R19, R20	RES., 5.1k, 5%, 1/16W, 0402	NIC, NRC04J512TRF
56	4	R21, R23, R37, R38	RES., 100k, 5%, 1/16W, 0402	YAGEO, RC0402JR-07100KL
57	3	R26, R33, R34	RES., 1MΩ, 5%, 1/16W, 0402	YAGEO, RC0402JR-071ML
58	3	R39-R41	RES., 1k, 5%, 1/16W, 0402	NIC, NRC04J102TRF
59	0	R42-R51	DNP	
60	1	U2	IC, MEMORY, EEPROM, 2Kb (256 × 8), TSSOP-8, 400kHz	MICROCHIP, 24LC025-I/ST
61	0	Z1	DNP	
Hardware for Demo Board Only				
62	11	E1-E6, E8, E10-E12, E17	TEST POINT, TURRET, 0.094", MTG. HOLE	MILL-MAX, 2501-2-00-80-00-00-07-0
63	6	E7, E9, E13-E16	TEST POINT, TURRET, 0.064", MTG. HOLE	MILL-MAX, 2308-2-00-80-00-00-07-0
64	1	J1	CONN., HDR., MALE, 2mm × 7mm, 2mm, THT, VERT, SHROUDED	MOLEX, 87831-1420
65	1	JP1	CONN., HDR, MALE, 1mm × 3mm, 2mm, THT, STR	WURTH ELEKTRONIK, 62000311121

DEMO MANUAL

DC2464A-A/DC2464A-B

PARTS LIST – DC2464A-B

ITEM	QTY	REFERENCE	PART DESCRIPTION	MANUFACTURER/PART NUMBER
Required Circuit Components				
1	1	C1	CAP, 1µF, X5R, 50V, 10%, 0603, AEC-Q200	TDK, CGA3E3X5R1H105K080AB
2	1	C2	CAP, 120pF, COG, 50V, 5%, 0402	MURATA, GRM1555C1H121JA01D
3	6	C6-C9, C15, C16	CAP, 10µF, X5R, 50V, 10%, 1206	MURATA, GRM31CR61H106KA12L
4	2	C10, C11	CAP, 33µF, ALUM., 50V, 20%, SMD 6.3mm × 7.7mm, AEC-Q200	PANASONIC, EEHZA1H330XP
5	2	C13, C14	CAP, 0.1µF, X7R, 50V, 10%, 0402	MURATA, GRM155R71H104KE14D
6	1	C17	CAP, 4.7µF, X5R, 16V, 10%, 0603	AVX, 0603YD475KAT2A
7	4	C18, C25, C26, CBST1	CAP, 0.1µF, X7R, 16V, 10%, 0402	AVX, 0402YC104KAT2A
8	4	C19, C20, C22, C23	CAP, 22µF, X5R, 16V, 20%, 0805	TDK, C2012X5R1C226M125AC
9	1	C21	CAP, 1µF, X5R, 16V, 10%, 0402	TAIYO YUDEN, EMK105BJ105KV-F
10	1	C24	CAP, 220pF, COG, 50V, 5%, 0402	AVX, 04025A221JAT2A
11	1	C28	CAP, 1200pF, X7R, 50V, 10%, 0402	AVX, 04025C122KAT2A
12	4	CAP1-CAP4	CAP, 10F, ULTRA, 2.7V, -10/+20%, THT, RADIAL	NESSCAP, ESHSR-0010C0-002R7
13	1	CSS1	CAP.CER., 0.022µF, 100V, X7R, 0603	TDK, C1608X7R2A223K080AA
14	1	CTIMER1	CAP, 0.033µF, X5R, 16V, 10%, 0402, AEC-Q200	TDK, CGA2B2X5R1C333K050BA
15	1	D1	DIODE, TVS, UNI-DIR., 30V, 600W, SMB	LITTELFUSE, SMBJ30A
16	1	DBST1	DIODE, GP SWITCHING, 80V, 125mA, SOD523, AEC-Q10X	DIODES INC., 1N4448HWT-7
17	1	L1	IND., 6.8µH, PWR, 20%, 9.2A, 19.62mΩ, SMD 7.2mm × 7.5mm, AEC-Q200	COILCRAFT, XAL7070-682MEB
18	4	M1-M4	XSTR., N-CH, 40V, 17.6A, PowerPAK 1212-8	VISHAY, SIS434DN-T1-GE3
19	2	R4, R5	RES., 10Ω, 5%, 1/16W, 0402	VISHAY, CRCW040210R0JNED
20	1	R11	RES., 649k, 1%, 1/16W, 0402	NIC, NRC04F6493TRF
21	1	R12	RES., 46.4k, 1%, 1/16W, 0402	VISHAY, CRCW040246K4FKED
22	1	R14	RES., 100Ω, 1%, 1/16W, 0402	NIC, NRC04F1000TRF
23	1	R15	RES., 665k, 1%, 1/16W, 0402	NIC, NRC04F6653TRF
24	1	R17	RES., 14.3k, 1%, 1/16W, 0402	VISHAY, CRCW040214K3FKED
25	1	R18	RES., AEC-Q200, 28k, 1%, 1/16W, 0402	VISHAY, CRCW040228K0FKED
26	5	R25, R27, R29, R30, R32	RES., ANTI-SURGE, AEC-Q200, 2.7Ω, 5%, 1/2W, 0805	PANASONIC, ERJ-P6WJ2R7V
27	1	R35	RES., 866k, 1%, 1/16W, 0402	NIC, NRC04F8663TRF
28	1	R36	RES., 118k, 1%, 1/16W, 0402	NIC, NRC04F1183TRF
29	1	RITST1	RES., AEC-Q200, 35.7Ω, 1%, 1/16W, 0402	VISHAY, CRCW040235R7FKED
30	1	RSNSC1	RES., SENSE, 0.005Ω, 1%, 1W, 1206 (0612)	SUSUMU, PRL1632-R005-F-T1
31	1	RSNSH1	RES., SENSE, 0.012Ω, 1%, 1W, 1206 (0612)	SUSUMU, PRL1632-R012-F-T1
32	1	RSNSI1	RES., SENSE, AEC-Q200, 0.004Ω, 1%, 1.5W, 1206 (0612)	SUSUMU, KRL3216E-C-R004-F-T1
33	1	RT1	RES., 107k, 1%, 1/16W, 0402	VISHAY, CRCW0402107KFKED
34	1	U1	IC, HOT SWAPPABLE SUPERCAPACITOR CHARGER BACKUP CONTROLLER AND SYSTEM MONITOR	ADI, LTC3351EUFF#PBF

DEMO MANUAL

DC2464A-A/DC2464A-B

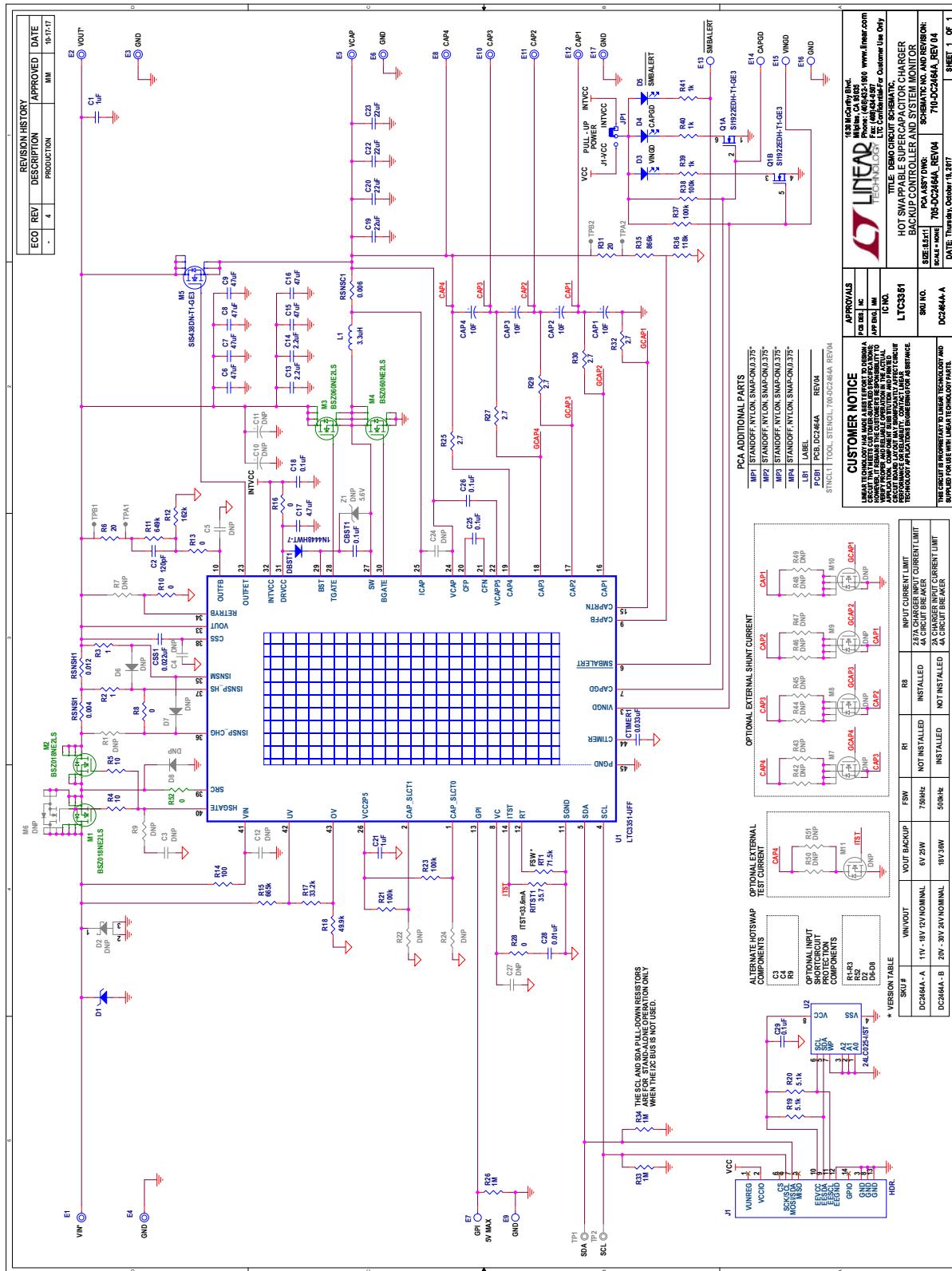
PARTS LIST – DC2464A-B

ITEM	QTY	REFERENCE	PART DESCRIPTION	MANUFACTURER/PART NUMBER
Additional Demo Board Circuit Components				
35	0	C3, C4	DNP	
36	0	C5,C12,C27	DNP	
37	1	C29	CAP, 0.1µF, X7R, 16V, 10%, 0402	AVX, 0402YC104KAT2A
38	1	D2	DIODE, SCHOTTKY, 40V, 10A, PowerDI5	DIODES INC., PDS1040L-13
39	2	D3, D4	LED, GREEN, MILKY WHITE DIFF, 0603 SMD, 565nm	LUMEX, SML-LX0603GW-TR
40	1	D5	LED, SUPER RED, MILKY WHITE DIFF, 0603 SMD, 660nm	LUMEX, SML-LX0603SRW-TR
41	3	D6-D8	DIODE, SBR, 40V, 1A, SOD123F	DIODES INC., 1N5819HW1-7-F
42	0	M5	DNP	
43	0	M6	DNP	
44	0	M7-M10	DNP	
45	0	M11	DNP	
46	1	Q1	XSTR., MOSFET, DUAL N-CH, 20V, 1.3A, SOT-363	VISHAY, Si1922EDH-T1-GE3
47	3	R1-R3	RES., 1Ω, 1%, 1/16W, 0402	VISHAY, CRCW04021R00FKED
48	2	R6, R31	RES., 20Ω, 1%, 1/16W, 0402	NIC, NRC04F20R0TRF
49	0	R7, R9, R22, R24	DNP	
50	0	R8	DNP	
51	4	R10, R13, R16, R28	RES., 0Ω, 1/16W, 0402	ROHM, MCR01MZPJ000
52	2	R19, R20	RES., 5.1k, 5%, 1/16W, 0402	NIC, NRC04J512TRF
53	4	R21, R23, R37, R38	RES., 100k, 5%, 1/16W, 0402	YAGEO, RC0402JR-07100KL
54	3	R26, R33, R34	RES., 1MΩ, 5%, 1/16W, 0402	YAGEO, RC0402JR-071ML
55	3	R39-R41	RES., 1k, 5%, 1/16W, 0402	NIC, NRC04J102TRF
56	0	R42-R51	DNP	
57	1	R52	RES., 10Ω, 5%, 1/16W, 0402	VISHAY, CRCW04021R0JNED
58	1	U2	IC, MEMORY, EEPROM, 2KB (256 × 8), TSSOP-8, 400kHz	MICROCHIP, 24LC025-I/ST
Hardware-For Demo Board Only				
59	11	E1-E6, E8, E10-E12, E17	TEST POINT, TURRET, 0.094", MTG. HOLE	MILL-MAX, 2501-2-00-80-00-00-07-0
60	6	E7, E9, E13-E16	TEST POINT, TURRET, 0.064", MTG. HOLE	MILL-MAX, 2308-2-00-80-00-00-07-0
61	1	J1	CONN., HDR., MALE, 2 × 7, 2mm, THT, VERT, SHROUDED	MOLEX, 87831-1420
62	1	JP1	CONN., HDR, MALE, 1 × 3, 2mm, THT, STR	WURTH ELEKTRONIK, 62000311121

DEMO MANUAL

DC2464A-A/DC2464A-B

SCHEMATIC DIAGRAM – DC2464A-A

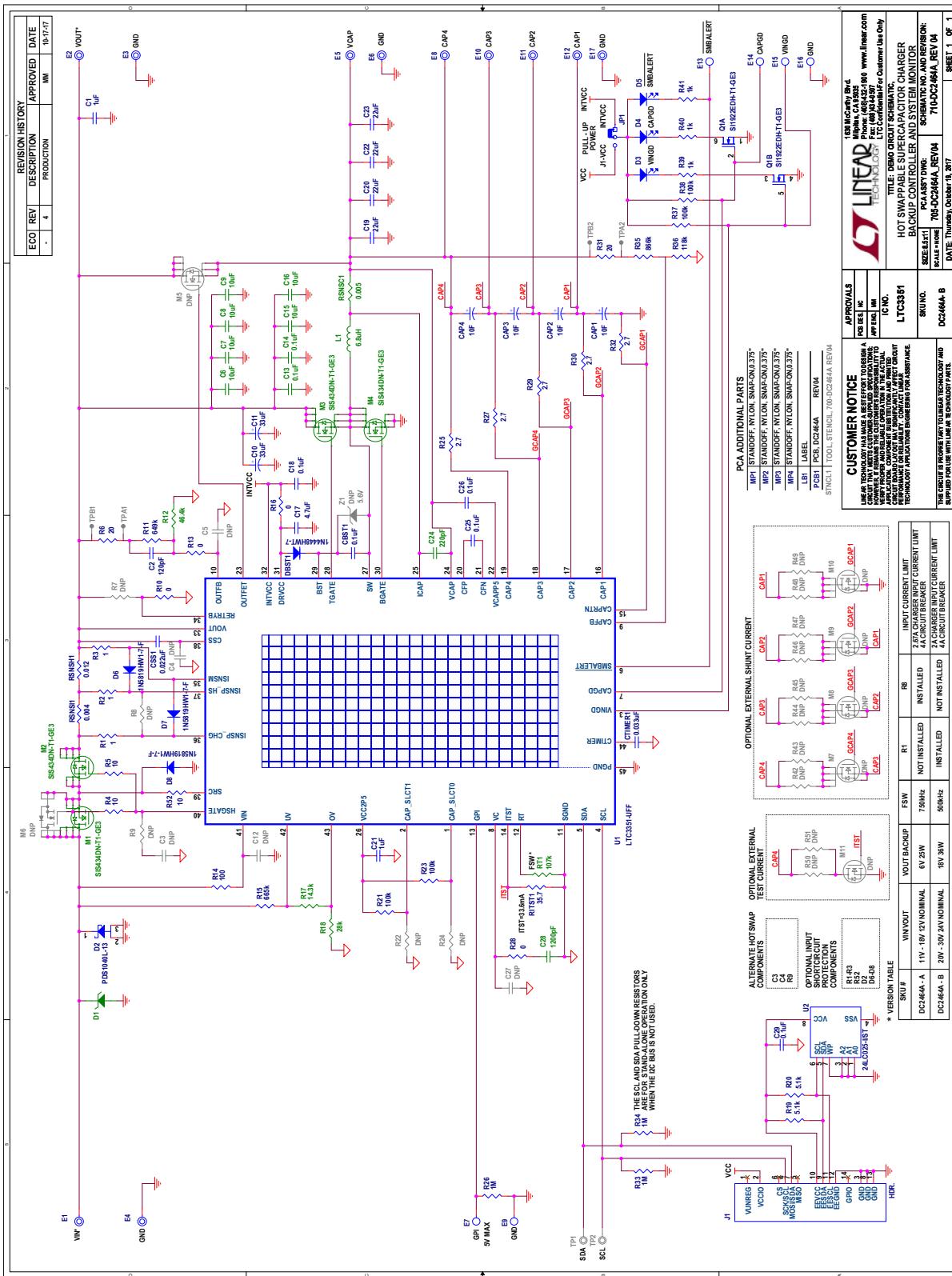


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DEMO MANUAL

DC2464A-A/DC2464A-B

SCHEMATIC DIAGRAM - DC2464A-B



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DEMO MANUAL

DC2464A-A/DC2464A-B



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ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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